

PART NUMBER LF157H-ROC

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All re-creations are done with the approval of the Original Component Manufacturer. (OCM)

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-38535
 - Class Q Military
 - Class V Space Level

Qualified Suppliers List of Distributors (QSLD)

 Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.



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National Semiconductor is now part of Texas Instruments.

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MICROCIRCUIT DATA SHEET

Original Creation Date: 06/20/95 Last Update Date: 09/12/02 Last Major Revision Date: 09/05/02

MONOLITHIC JFET INPUT OPERATIONAL AMPLIFIERS

General Description

MNLF157-X REV 1A1

These are the first monolithic JFET input operational amplifiers to incorporate well matched, high voltage JFETs on the same chip with standard bipolar transistors (BI-FET(TM) Technology). These amplifiers feature low input bias and offset currents/low offset voltage and offset voltage drift, coupled with offset adjust which does not degrade drift or common-mode rejection. The devices are also designed for high slew rate, wide bandwidth, extremely fast settling time, low voltage and current noise and a low 1/f noise corner.

Industry Part Number

NS Part Numbers

LF157

LF157H/883

Prime Die

LF157

Processing	Subgrp	Description	Temp (°C)
MIL-STD-883, Method 5004		Static tests at	+25
	2	Static tests at	+125
	3	Static tests at	-55
Quality Conformance Inspection	4	Dynamic tests at	+25
guarro, communico improvoron	5	Dynamic tests at	+125
MIL-STD-883, Method 5005	6	Dynamic tests at	-55
MIL-SID-003, Method 3003	7	Functional tests at	+25
	8A	Functional tests at	+125
	8B	Functional tests at	-55
	9	Switching tests at	+25
	10	Switching tests at	+125
	11	Switching tests at	-55

- Low input noise voltage

Features

- Low input bias current 30 pA - Low input offset current 3 pA - High input impedance 10e12 Ohms - Low input offset voltage 1 mV 3 uV/ C - Low input offset voltage temp. drift - Low input noise current 0.01 pA/sqrtHz - High common-mode rejection ratio 100 dB - Large dc voltage gain 106 dB - Extremely fast settling time to 0.01% 1.5 uS - Fast slew rate 50 V/uS - Wide gain bandwidth 20 MHz

12 nV/sqrtHz

(Absolute Maximum Ratings)

(Note 1)

Supply Voltage <u>+</u>22V Differential Input Voltage ±40V Input Voltage Range (Note 4) ±20V Output Short Circuit Duration Continuous Timax 150 C Power Dissipation at Ta=25 C 560mW (Still Air) (Note 2, 3) (500 LF/Min Air Flow) 1200mW Thermal Resistance ThetaJA (Still Air) 162 C/W (500LF/Min Air flow) 89 C/W ThetaJC 32 C/W Storage Temperature Range -65 C \leq Ta \leq +150 C Lead Temperature (Soldering, 10 seconds) 300 C ESD tolerance

Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. Some performance characteristics may

1200V

- degrade when the device is not operated under the listed test conditions. The maximum power dissipation must be derated at elevated temperatures and is dictated by Tjmax (maximum junction temperature), ThetaJA (package junction to ambient thermal resistance), and TA (ambient temperature). The maximum allowable Note 2: power dissipation at any temperature is Pdmax = (Tjmax - TA)/ThetaJA or the number
- given in the Absolute Maximum Ratings, whichever is lower.

 Maximum Power Dissipation is deined by the package characteristics. Operating the part near the Maximum Power Dissipation may cause the part to operate outside Note 3: guaranteed limits.
- Unless otherwise specified the absolute maximum negative input voltage is equal to Note 4: the negative power supply voltage.

 Note 5: Human body model, 100pF discharged through 1.5k Ohms.

Electrical Characteristics

DC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.) DC: Vcc = ± 15 V, Vcm = 0V, Rs = 50 Ohms

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN- NAME	MIN	MAX	UNIT	SUB- GROUPS
Vio	Input Offset Voltage				-5	5	mV	1
	Volume				-7	7	mV	2, 3
		$Vcc = \pm 20V$			-5	5	mV	1
					-7	7	mV	2, 3
Iio	Input Offset Current				-0.02	0.02	nA	1
	Gullens				-20	20	nA	2, 3
		Vcm = 11V			-0.02	0.02	nA	1
					-20	20	nA	2, 3
		Vcm = -11V			-0.02	0.02	nA	1
					-20	20	nA	2, 3
		$Vcc = \pm 20V$			-0.02	0.02	nA	1
					-20	20	nA	2, 3
Ibias	Input Bias Current					0.1	nA	1
	Current					50	nA	2, 3
		Vcm = 11V				0.1	nA	1
						50	nA	2, 3
		Vcm = -11V				0.1	nA	1
						50	nA	2, 3
		$Vcc = \pm 20V$				0.1	nA	1
						50	nA	2, 3
PSRR	Power Supply Rejection Ratio	$Vcc = \pm 20V to \pm 10V$			85		dB	1, 2,
CMRR	Common Mode Rejection Ratio	Vcm = <u>+</u> 11V			85		dB	1, 2,
+Vio/Adj	Input Offset Voltage Adjust				10		mV	1, 2,
-Vio/Adj	Input Offset Voltage Adjust					-10	mV	1, 2,
Icc	Power Supply					7	mA	1
	Current					9	mA	2, 3
		$Vcc = \pm 20V$				9	mA	1
+Ios	Short Circuit Current	Vout = 0V			-35	-15	mA	1

Electrical Characteristics

DC PARAMETERS (Continued)

(The following conditions apply to all the following parameters, unless otherwise specified.) DC: $Vcc = \pm 15V$, Vcm = 0V, Rs = 50 Ohms

SYMBOL	PARAMETER	CONDITIONS		PIN- NAME	MIN	MAX	UNIT	SUB- GROUPS
-Ios	Short Circuit Current	Vout = 0V			15	35	mA	1
+Vop	Output Voltage Swing	Rl 10K Ohms			12		V	4, 5, 6
		Rl 2K Ohms			10		V	4, 5, 6
-Vop	Output Voltage Swing	R1 10K Ohms				-12	V	4, 5, 6
		Rl 2K Ohms				-10	v	4, 5, 6
+Avs	Large Signal Voltage Gain	R1 = 2K Ohms, Vout = 0 to 10V			50		V/mV	4
	voreage carn				25		V/mV	5, 6
-Avs	Large Signal Voltage Gain	Rl = 2K Ohms, Vout = 0 to -10V			50		V/mV	4
	voicage dain				25		V/mV	5, 6

AC PARAMETERS

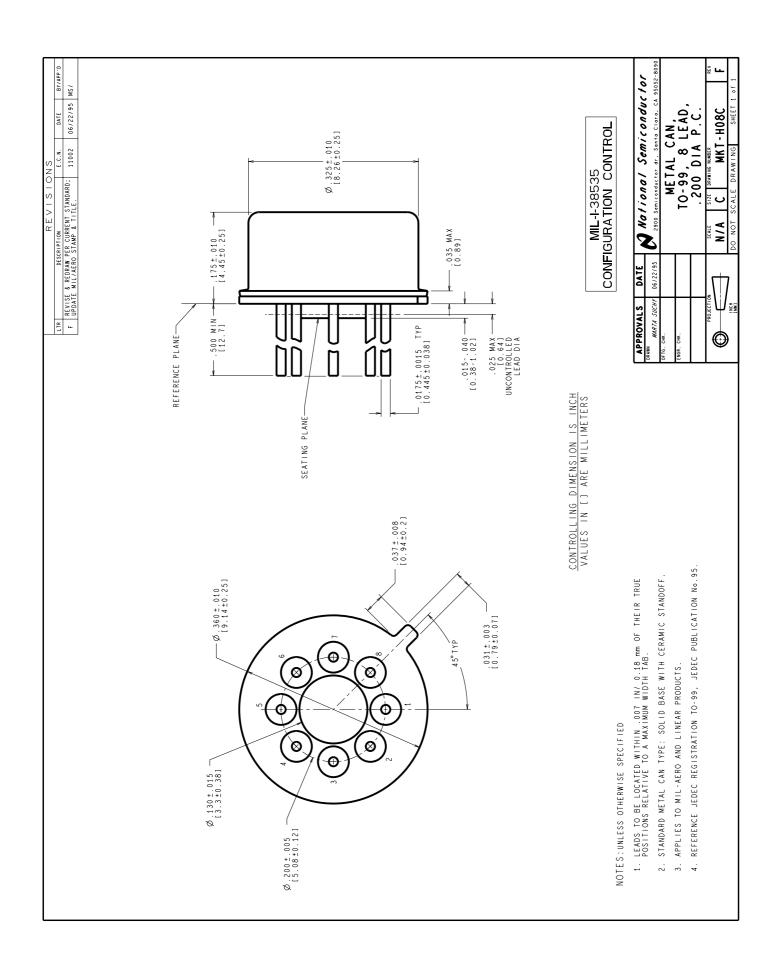
(The following conditions apply to all the following parameters, unless otherwise specified.) AC: $Vcc = \pm 15V$, Vcm = 0V, Rs = 50 Ohms

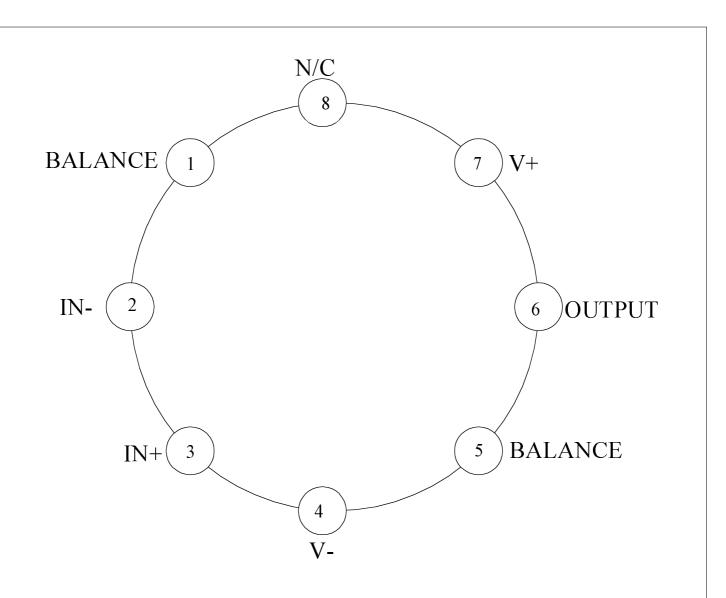
+Sr	Slew Rate	Av = 5, Rload = 2K Ohms, Cload = 100pfd, Vin = -1V to +1V, Vout = -5V to +5V				V/uS	9
-Sr	Slew Rate					V/uS	9
Gbw	Gain Bandwidth			1	15	MHz	9

Graphics and Diagrams

GRAPHICS#	DESCRIPTION			
05094HRB3	METAL CAN (H), TO-99, 8LD .200 DIA P.C. (B/I CKT)			
H08CRF	METAL CAN (H), TO-99, 8LD, .200 DIA P.C. (P/P DWG)			
P000295A	METAL CAN (H), 8 LEAD (PINOUT)			

See attached graphics following this page.





LF157AH, LF157H
8 - PIN METAL CAN
CONNECTION DIAGRAM
TOP VIEW
P000295A



Revision History

Rev	ECN #	Rel Date	Originator	Changes
1A1	M0004064	09/12/02		Update MDS to fully Released datasheet: MNLF157-X, Rev. 0BL to MNLF157-X, Rev. 1Al. Changed AC Parameters Section, +SR Condition From: Av = 5, Vin = -5V to +5V TO: Av = 5, Rload = 2K Ohms, Cload = 100pfd, Vin = -1V to +1V, Vout = -5V to +5V and -SR Condition From: Av = 5, Vin = +5V to -5V TO: Av = 5, Rload = 2K Ohms, Cload = 100pfd, Vin = +1V to -1V, Vout = +5V to -5V . Condition Changed to match Test Tape.